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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I ² C), SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	40
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 20x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f344-gqr

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D



Figure 1.5. C8051F34A/B Block Diagram



4. Pinout and Package Definitions

Table 4.1. Pin Definitions for the C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

Namo	Pin Numbers		Type	Description			
Name	48-pin	32-pin	Type	Description			
V _{DD}	10	6	Power In	2.7–3.6 V Power Supply Voltage Input.			
			Power Out	3.3 V Voltage Regulator Output. See Section 8 .			
GND	7	3		Ground.			
RST/	13	9	D I/O	Device Reset. Open-drain output of internal POR or V_{DD} monitor. An external source can initiate a system reset by driving this pin low for at least 15 µs. See Section 11 .			
C2CK			D I/O	Clock signal for the C2 Debug Interface.			
C2D	14		D I/O	Bi-directional data signal for the C2 Debug Interface.			
P3.0 /		10	D I/O	Port 3.0. See Section 15 for a complete description of Port 3.			
020			0 17 0	Bi-directional data signal for the C2 Debug Interface.			
REGIN	11	7	Power In	5 V Regulator Input. This pin is the input to the on-chip volt- age regulator.			
VBUS	12	8	D In	VBUS Sense Input. This pin should be connected to the VBUS signal of a USB network. A 5 V signal on this pin indicates a USB network connection.			
D+	8	4	D I/O	USB D+.			
D-	9	5	D I/O	USB D–.			
P0.0	6	2	D I/O or A In	Port 0.0. See Section 15 for a complete description of Port 0.			
P0.1	5	1	D I/O or A In	Port 0.1.			
P0.2	4	32	D I/O or A In	Port 0.2.			
P0.3	3	31	D I/O or A In	Port 0.3.			
P0.4	2	30	D I/O or A In	Port 0.4.			
P0.5	1	29	D I/O or A In	Port 0.5.			
P0.6	48	28	D I/O or A In	Port 0.6.			
P0.7	47	27	D I/O or A In	Port 0.7.			



C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

SFR Definition 5.3. ADC0CF: ADC0 Configuration

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value		
AD0SC4	4 AD0SC3	AD0SC2	AD0SC1	AD0SC0	AD0LJST	-	-	11111000		
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:		
								0xBC		
Bits7–3:	Bits7–3: AD0SC4–0: ADC0 SAR Conversion Clock Period Bits. SAR Conversion clock is derived from system clock by the following equation, where AD0SC refers to the 5-bit value held in bits AD0SC4-0. SAR Conversion clock requirements are given in Table 5.1. $AD0SC = \frac{SYSCLK}{CLK_{SAR}} - 1$									
Bit2:	AD0LJST: ADC0 Left Justify Select. 0: Data in ADC0H:ADC0L registers are right-justified. 1: Data in ADC0H:ADC0L registers are left-justified.									
Bits1–0:	UNUSED. R	ead = 00b;	Write = dor	n't care.						

SFR Definition 5.4. ADC0H: ADC0 Data Word MSB



SFR Definition 5.5. ADC0L: ADC0 Data Word LSB

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value	
								0000000	
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:	
								0xBD	
Bits7–0: ADC0 Data Word Low-Order Bits. For AD0LJST = 0: Bits 7–0 are the lower 8 bits of the 10-bit Data Word. For AD0LJST = 1: Bits 7–6 are the lower 2 bits of the 10-bit Data Word. Bits 5–0 will always read '0'.									



6. Voltage Reference (C8051F340/1/2/3/4/5/6/7/A/B Only)

The Voltage reference MUX on C8051F34x devices is configurable to use an externally connected voltage reference, the on-chip reference voltage generator, or the power supply voltage V_{DD} (see Figure 6.1). The REFSL bit in the Reference Control register (REF0CN) selects the reference source. For the internal reference or an external source, REFSL should be set to '0'; For V_{DD} as the reference source, REFSL should be set to '1'.

The BIASE bit enables the internal ADC bias generator, which is used by the ADC and Internal Oscillator. This enable is forced to logic 1 when either of the aforementioned peripherals is enabled. The ADC bias generator may be enabled manually by writing a '1' to the BIASE bit in register REFOCN; see SFR Definition 6.1 for REFOCN register details. The Reference bias generator (see Figure 6.1) is used by the Internal Voltage Reference, Temperature Sensor, and Clock Multiplier. The Reference bias is automatically enabled when any of the aforementioned peripherals are enabled. The electrical specifications for the voltage reference and bias circuits are given in Table 6.1.

Important Note About the VREF Pin: The VREF pin, when not using the on-chip voltage reference or an external precision reference, can be configured as a GPIO Port pin. When using an external voltage reference or the on-chip reference, the VREF pin should be configured as analog pin and skipped by the Digital Crossbar. To configure the VREF pin for analog mode, set the corresponding bit in the PnMDIN register to '0'. To configure the Crossbar to skip the VREF pin, set the corresponding bit in register PnSKIP to '1'. Refer to **Section "15. Port Input/Output" on page 142** for complete Port I/O configuration details.

The temperature sensor connects to the ADC0 positive input multiplexer (see **Section "5.1. Analog Multiplexer" on page 42** for details). The TEMPE bit in register REF0CN enables/disables the temperature sensor. While disabled, the temperature sensor defaults to a high impedance state and any ADC0 measurements performed on the sensor result in meaningless data.



Figure 6.1. Voltage Reference Functional Block Diagram



Table 7.1. Comparator Electrical Characteristics

V_{DD} = 3.0 V, -40 to +85 °C unless otherwise noted.

All specifications apply to both Comparator0 and Comparator1 unless otherwise noted.

Parameter	Conditions	Min	Тур	Max	Units
Response Time:	CP0+ - CP0- = 100 mV		100		ns
Mode 0, Vcm* = 1.5 V	CP0+ - CP0- = -100 mV		250		ns
Response Time:	CP0+ - CP0- = 100 mV		175		ns
Mode 1, Vcm* = 1.5 V	CP0+ - CP0- = -100 mV		500		ns
Response Time:	CP0+ - CP0- = 100 mV		320		ns
Mode 2, Vcm* = 1.5 V	CP0+ - CP0- = -100 mV		1100		ns
Response Time:	CP0+ - CP0- = 100 mV		1050		ns
Mode 3, Vcm* = 1.5 V	CP0+ - CP0- = -100 mV		5200		ns
Common-Mode Rejection Ratio			1.5	4	mV/V
Positive Hysteresis 1	CP0HYP1-0 = 00		0	1	mV
Positive Hysteresis 2	CP0HYP1-0 = 01	2	5	10	mV
Positive Hysteresis 3	CP0HYP1-0 = 10	7	10	20	mV
Positive Hysteresis 4	CP0HYP1–0 = 11	15	20	30	mV
Negative Hysteresis 1	CP0HYN1-0 = 00		0	1	mV
Negative Hysteresis 2	CP0HYN1-0 = 01	2	5	10	mV
Negative Hysteresis 3	CP0HYN1-0 = 10	7	10	20	mV
Negative Hysteresis 4	CP0HYN1–0 = 11	15	20	30	mV
Inverting or Non-Inverting Input Voltage Range		-0.25		V _{DD} + 0.25	V
Input Capacitance			3		pF
Input Bias Current			0.001		nA
Input Offset Voltage		-5		+5	mV
	Power Supp	ly			
Power Supply Rejection			0.1		mV/V
Power-up Time			10		μs
	Mode 0		7.6		μA
Supply Current at DC	Mode 1		3.2		μA
	Mode 2		1.3		μA
	Mode 3		0.4		μA

*Note: Vcm is the common-mode voltage on CP0+ and CP0-.



Reset Value										
00000000										
SFR Address:										
0xD0										
() · · · · · · · · · · · · · · · · · ·										
CY: Carry Flag.										
borrow										
a borrow										
operations.										
n all other										
ared if the										
 OV: Overflow Flag. This bit is set to 1 under the following circumstances: An ADD, ADDC, or SUBB instruction causes a sign-change overflow. A MUL instruction results in an overflow (result is greater than 255). A DIV instruction causes a divide-by-zero condition. The OV bit is cleared to 0 by the ADD, ADDC, SUBB, MUL, and DIV instructions in all other cases. F1: User Flag 1. This is a bit-addressable, general purpose flag for use under software control. PARITY: Parity Flag. This bit is set to logic 1 if the sum of the eight bits in the accumulator is odd and cleared if the sum is even. 										

SFR Definition 9.5. ACC: Accumulator

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value			
ACC.7	ACC.6	ACC.5	ACC.4	ACC.3	ACC.2	ACC.1	ACC.0	00000000			
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:			
	(bit addressable) 0xE0										
Bits7–0: ACC: Accumulator. This register is the accumulator for arithmetic operations.											



11.3. External Reset

The external RST pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the RST pin generates a reset; an external pull-up and/or decoupling of the RST pin may be necessary to avoid erroneous noise-induced resets. See Table 11.1 for complete RST pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

11.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If more than 100 µs pass between rising edges on the system clock, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read '1', signifying the MCD as the reset source; otherwise, this bit reads '0'. Writing a '1' to the MCDRSF bit enables the Missing Clock Detector; writing a '0' disables it. The state of the RST pin is unaffected by this reset.

11.5. Comparator0 Reset

Comparator0 can be configured as a reset source by writing a '1' to the CORSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to CORSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0-), a system reset is generated. After a Comparator0 reset, the CORSEF flag (RSTSRC.5) will read '1' signifying Comparator0 as the reset source; otherwise, this bit reads '0'. The state of the RST pin is unaffected by this reset.

11.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in **Section "22.3. Watchdog Timer Mode" on page 264**; the WDT is enabled and clocked by SYSCLK / 12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to '1'. The state of the RST pin is unaffected by this reset.

11.7. Flash Error Reset

If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to "1", and a MOVX write operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read is attempted above user code space. This occurs when a MOVC operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Program read is attempted above user code space. This occurs when user code attempts to branch to an address above 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read, write or erase attempt is restricted due to a Flash security setting (see Section "12.3. Security Options" on page 109).
- A Flash Write or Erase is attempted when the V_{DD} monitor is not enabled.

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the \overline{RST} pin is unaffected by this reset.



Parameter	Conditions	Min	Тур	Max	Units
Floop Size	C8051F340/2/4/6/A/C/D*	65536*			Bytes
Flash Size	C8051F341/3/5/7/8/9/B	32768			Bytes
Endurance		20k	100k		Erase/Write
Erase Cycle Time	25 MHz System Clock	10	15	20	ms
Write Cycle Time	25 MHz System Clock	40	55	70	μs

Table 12.1. Flash Electrical Characteristics

*Note: 1024 bytes at location 0xFC00 to 0xFFFF are reserved.

12.2. Non-Volatile Data Storage

The Flash memory can be used for non-volatile data storage as well as program code. This allows data such as calibration coefficients to be calculated and stored at run time. Data is written using the MOVX write instruction and read using the MOVC instruction. Note: MOVX read instructions always target XRAM.

12.3. Security Options

The CIP-51 provides security options to protect the Flash memory from inadvertent modification by software as well as to prevent the viewing of proprietary program code and constants. The Program Store Write Enable (bit PSWE in register PSCTL) and the Program Store Erase Enable (bit PSEE in register PSCTL) bits protect the Flash memory from accidental modification by software. PSWE must be explicitly set to '1' before software can modify the Flash memory; both PSWE and PSEE must be set to '1' before software can erase Flash memory. Additional security features prevent proprietary program code and data constants from being read or altered across the C2 interface.

A Security Lock Byte located at the last byte of Flash user space offers protection of the Flash program memory from access (reads, writes, or erases) by unprotected code or the C2 interface. The Flash security mechanism allows the user to lock n 512-byte Flash pages, starting at page 0 (addresses 0x0000 to 0x01FF), where n is the 1's complement number represented by the Security Lock Byte. Note that the page containing the Flash Security Lock Byte is also locked when any other Flash pages are locked. See example below.

Security Lock Byte:	11111101b
1's Complement:	0000010b
Flash pages locked:	3 (2 + Flash Lock Byte Page)
	First two pages of Flash: 0x0000 to 0x03FF
Addresses locked:	Flash Lock Byte Page: (0xFA00 to 0xFBFF for 64k devices; 0x7E00 to 0x7FFF for 32k devices)



13.7.2. Multiplexed Mode

13.7.2.1.16-bit MOVX: EMI0CF[4:2] = '001', '010', or '011'.



Figure 13.8. Multiplexed 16-bit MOVX Timing



C8051F340/1/2/3/4/5/6/7/8/9/A/B/C/D

13.7.2.3.8-bit MOVX with Bank Select: EMI0CF[4:2] = '010'.







Table 14.1. Oscillator Electrical Characteristics

V_{DD} = 2.7 to 3.6 V; -40 to +85 °C unless otherwise specified

Parameter	Min	Тур	Max	Units						
Internal High-Frequency Oscillator (Using Factory-Calibrated Settings)										
Oscillator Frequency	IFCN = 11b	11.82	12.00	12.18	MHz					
Oscillator Supply Current (from V _{DD})	24 °C, V _{DD} = 3.0 V, OSCICN.7 = 1	_	685	_	μA					
Internal Low-Frequency Osc	Ilator (Using Factory-Calibrated S	Settings)							
Oscillator Frequency	OSCLD = 11b	72	80	99	kHz					
Oscillator Supply Current (from V _{DD})	24 °C, V _{DD} = 3.0 V, OSCLCN.7 = 1	_	7.0	_	μA					
External USB Clock Requirements										
USD Clock Frequency*	Full Speed Mode	47.88	48	48.12						
	Low Speed Mode	5.91	6	6.09	IVIEZ					

*Note: Applies only to external oscillator sources.

	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value	
ſ				USB	DAT				00000000	
L	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x97	
		This SFR is	used to indi	irectly read	and write U	SB0 registe	ers.			
		Write Procee	dure:							
		1. Poll for B	USY (USB	0ADR.7) =	> '0'.					
		2. Load the	target USB	0 register a	ddress into	the USBAD	DR bits in i	register U	SB0ADR.	
		3. Write dat	a to USB0D	DAT.						
		4. Repeat (Step 2 may	be skipped	when writir	ig to the sai	me USB0 re	egister).		
		Read Proces	duro:							
		1 Poll for B	USY (USB	(ADR 7) =	> '0'					
		2. Load the	target USB	0 register a	ddress into	the USBAD	DR bits in i	reaister U	SB0ADR.	
		3. Write '1'	to the BUSY	/ bit in regis	ter USB0A	DR (steps 2	and 3 can	be perfori	med in the	
		same write).								
		4. Poll for B	USY (USB	0ADR.7) =	> '0'.					
		5. Read dat	a from USB	BODAT.						
 Repeat from Step 2 (Step 2 may be skipped when reading the same USB0 reg may be skipped when the AUTORD bit (USB0ADR.6) is logic 1). 									egister; Step 3	

SFR Definition 16.3. USB0DAT: USB0 Data



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Bit	Set by Hardware When:	Cleared by Hardware When:
MASTER	A START is generated.	A STOP is generated.
		 Arbitration is lost.
	 START is generated. 	 A START is detected.
TXMODE	 SMB0DAT is written before the start of an 	 Arbitration is lost.
TXWODE	SMBus frame.	SMB0DAT is not written before the
		start of an SMBus frame.
STA	• A START followed by an address byte is	 Must be cleared by software.
	received.	
070	• A STOP is detected while addressed as a	• A pending STOP is generated.
510	Slave.	
	Arbitration is lost due to a detected STOP.	After each ACK evolg
ACKRQ	• A byte has been received and an ACK	• Alter each ACK cycle.
	• A repeated STAPT is detected as a MASTEP	• Each time SLic cleared
	when STA is low (unwanted repeated START)	• Each time Shis cleared.
	• SCL is sensed low while attempting to gener-	
ARBLOST	ate a STOP or repeated START condition	
	• SDA is sensed low while transmitting a '1'	
	(excluding ACK bits).	
1.01/	• The incoming ACK value is low (ACKNOWL-	• The incoming ACK value is high (NOT
ACK	EDGE).	ACKNOWLEDGE).
	 A START has been generated. 	 Must be cleared by software.
SI	 Lost arbitration. 	
	 A byte has been transmitted and an ACK/ 	
	NACK received.	
	 A byte has been received. 	
	• A START or repeated START followed by a	
	slave address + R/W has been received.	
	 A STOP has been received. 	

Table 17.3. Sources for Hardware Changes to SMB0CN



17.4.3. Data Register

The SMBus Data register SMB0DAT holds a byte of serial data to be transmitted or one that has just been received. Software may safely read or write to the data register when the SI flag is set. Software should not attempt to access the SMB0DAT register when the SMBus is enabled and the SI flag is cleared to logic 0, as the interface may be in the process of shifting a byte of data into or out of the register.

Data in SMB0DAT is always shifted out MSB first. After a byte has been received, the first bit of received data is located at the MSB of SMB0DAT. While data is being shifted out, data on the bus is simultaneously being shifted in. SMB0DAT always contains the last data byte present on the bus. In the event of lost arbitration, the transition from master transmitter to slave receiver is made with the correct data or address in SMB0DAT.



SFR Definition 17.3. SMB0DAT: SMBus Data

17.5. SMBus Transfer Modes

The SMBus interface may be configured to operate as master and/or slave. At any particular time, it will be operating in one of the following four modes: Master Transmitter, Master Receiver, Slave Transmitter, or Slave Receiver. The SMBus interface enters Master Mode any time a START is generated, and remains in Master Mode until it loses an arbitration or generates a STOP. An SMBus interrupt is generated at the end of all SMBus byte frames; however, note that the interrupt is generated before the ACK cycle when operating as a receiver, and after the ACK cycle when operating as a transmitter.

17.5.1. Master Transmitter Mode

Serial data is transmitted on SDA while the serial clock is output on SCL. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 0 (WRITE). The master then transmits one or more bytes of serial data. After each byte is transmitted, an acknowledge bit is generated by the slave. The transfer is ended when the STO bit is set and a STOP is generated. Note that the interface will switch to Master Receiver Mode if SMB0DAT is not written following a Master Transmitter interrupt. Figure 17.5 shows a typical Master Transmitter sequence. Two transmit data bytes are shown, though any number of bytes may be transmitted. Notice that the 'data byte transferred' interrupts occur **after** the ACK cycle in this mode.



18.2.2. 9-Bit UART

9-bit UART mode uses a total of eleven bits per data byte: a start bit, 8 data bits (LSB first), a programmable ninth data bit, and a stop bit. The state of the ninth transmit data bit is determined by the value in TB80 (SCON0.3), which is assigned by user software. It can be assigned the value of the parity flag (bit P in register PSW) for error detection, or used in multiprocessor communications. On receive, the ninth data bit goes into RB80 (SCON0.2) and the stop bit is ignored.

Data transmission begins when an instruction writes a data byte to the SBUF0 register. The TI0 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to '1'. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if the following conditions are met: (1) RI0 must be logic 0, and (2) if MCE0 is logic 1, the 9th bit must be logic 1 (when MCE0 is logic 0, the state of the ninth data bit is unimportant). If these conditions are met, the eight bits of data are stored in SBUF0, the ninth bit is stored in RB80, and the RI0 flag is set to '1'. A UART0 interrupt will occur if enabled when either TI0 or RI0 is set to '1'.





18.3. Multiprocessor Communications

9-Bit UART mode supports multiprocessor communication between a master processor and one or more slave processors by special use of the ninth data bit. When a master processor wants to transmit to one or more slaves, it first sends an address byte to select the target(s). An address byte differs from a data byte in that its ninth bit is logic 1; in a data byte, the ninth bit is always set to logic 0.

Setting the MCE0 bit (SCON0.5) of a slave processor configures its UART such that when a stop bit is received, the UART will generate an interrupt only if the ninth bit is logic 1 (RB80 = 1) signifying an address byte has been received. In the UART interrupt handler, software will compare the received address with the slave's own assigned 8-bit address. If the addresses match, the slave will clear its MCE0 bit to enable interrupts on the reception of the following data byte(s). Slaves that weren't addressed leave their MCE0 bits set and do not generate interrupts on the reception of the following data byte(s) addressed slave resets its MCE0 bit to ignore all transmissions until it receives the next address byte.

Multiple addresses can be assigned to a single slave and/or a single address can be assigned to multiple slaves, thereby enabling "broadcast" transmissions to more than one slave simultaneously. The master processor can be configured to receive all transmissions or a protocol can be implemented such that the master/slave role is temporarily reversed to enable half-duplex transmission between the original master and slave(s).



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19.2. Data Format

UART1 has a number of available options for data formatting. Data transfers begin with a start bit (logic low), followed by the data bits (sent LSB-first), a parity or extra bit (if selected), and end with one or two stop bits (logic high). The data length is variable between 5 and 8 bits. A parity bit can be appended to the data, and automatically generated and detected by hardware for even, odd, mark, or space parity. The stop bit length is selectable between short (1 bit time) and long (1.5 or 2 bit times), and a multi-processor communication mode is available for implementing networked UART buses. All of the data formatting options can be configured using the SMOD1 register, shown in SFR Definition 19.2. Figure 19.2 shows the timing for a UART1 transaction without parity or an extra bit enabled. Figure 19.3 shows the timing for a UART1 transaction with parity enabled (PE1 = 1). Figure 19.4 is an example of a UART1 transaction when the extra bit is enabled (XBE1 = 1). Note that the extra bit feature is not available when parity is enabled, and the second stop bit is only an option for data lengths of 6, 7, or 8 bits.



Figure 19.2. UART1 Timing Without Parity or Extra Bit



Figure 19.3. UART1 Timing With Parity



Figure 19.4. UART1 Timing With Extra Bit

20. Enhanced Serial Peripheral Interface (SPI0)

The Enhanced Serial Peripheral Interface (SPI0) provides access to a flexible, full-duplex synchronous serial bus. SPI0 can operate as a master or slave device in both 3-wire or 4-wire modes, and supports multiple masters and slaves on a single SPI bus. The slave-select (NSS) signal can be configured as an input to select SPI0 in slave mode, or to disable Master Mode operation in a multi-master environment, avoiding contention on the SPI bus when more than one master attempts simultaneous data transfers. NSS can also be configured as a chip-select output in master mode, or disabled for 3-wire operation. Additional general purpose port I/O pins can be used to select multiple slave devices in master mode.



Figure 20.1. SPI Block Diagram



21.2. Timer 2

Timer 2 is a 16-bit timer formed by two 8-bit SFRs: TMR2L (low byte) and TMR2H (high byte). Timer 2 may operate in 16-bit auto-reload mode, (split) 8-bit auto-reload mode, USB Start-of-Frame (SOF) capture mode, or Low-Frequency Oscillator (LFO) Falling Edge capture mode. The Timer 2 operation mode is defined by the T2SPLIT (TMR2CN.3), T2CE (TMR2CN.4) bits, and T2CSS (TMR2CN.1) bits.

Timer 2 may be clocked by the system clock, the system clock divided by 12, or the external oscillator source divided by 8. The external clock mode is ideal for real-time clock (RTC) functionality, where the internal oscillator drives the system clock while Timer 2 (and/or the PCA) is clocked by an external precision oscillator. Note that the external oscillator source divided by 8 is synchronized with the system clock.

21.2.1. 16-bit Timer with Auto-Reload

When T2SPLIT = '0' and T2CE = '0', Timer 2 operates as a 16-bit timer with auto-reload. Timer 2 can be clocked by SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. As the 16-bit timer register increments and overflows from 0xFFFF to 0x0000, the 16-bit value in the Timer 2 reload registers (TMR2RLH and TMR2RLL) is loaded into the Timer 2 register as shown in Figure 21.4, and the Timer 2 High Byte Overflow Flag (TMR2CN.7) is set. If Timer 2 interrupts are enabled, an interrupt will be generated on each Timer 2 overflow. Additionally, if Timer 2 interrupts are enabled and the TF2LEN bit is set (TMR2CN.5), an interrupt will be generated each time the lower 8 bits (TMR2L) overflow from 0xFF to 0x000.



Figure 21.4. Timer 2 16-Bit Mode Block Diagram



21.3.2. 8-bit Timers with Auto-Reload

When T3SPLIT is '1' and T3CE = '0', Timer 3 operates as two 8-bit timers (TMR3H and TMR3L). Both 8-bit timers operate in auto-reload mode as shown in Figure 21.5. TMR3RLL holds the reload value for TMR3L; TMR3RLH holds the reload value for TMR3H. The TR3 bit in TMR3CN handles the run control for TMR3H. TMR3L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 3 Clock Select bits (T3MH and T3ML in CKCON) select either SYSCLK or the clock defined by the Timer 3 External Clock Select bit (T3XCLK in TMR3CN), as follows:

ТЗМН	T3XCLK	TMR3H Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	Х	SYSCLK

T3ML	T3XCLK	TMR3L Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	Х	SYSCLK

The TF3H bit is set when TMR3H overflows from 0xFF to 0x00; the TF3L bit is set when TMR3L overflows from 0xFF to 0x00. When Timer 3 interrupts are enabled, an interrupt is generated each time TMR3H overflows. If Timer 3 interrupts are enabled and TF3LEN (TMR3CN.5) is set, an interrupt is generated each time either TMR3L or TMR3H overflows. When TF3LEN is enabled, software must check the TF3H and TF3L flags to determine the source of the Timer 3 interrupt. The TF3H and TF3L interrupt flags are not cleared by hardware and must be manually cleared by software.



Figure 21.9. Timer 3 8-Bit Mode Block Diagram



22.2. Capture/Compare Modules

Each module can be configured to operate independently in one of six operation modes: Edge-triggered Capture, Software Timer, High Speed Output, Frequency Output, 8-Bit Pulse Width Modulator, or 16-Bit Pulse Width Modulator. Each module has Special Function Registers (SFRs) associated with it in the CIP-51 system controller. These registers are used to exchange data with a module and configure the module's mode of operation.

Table 22.2 summarizes the bit settings in the PCA0CPMn registers used to select the PCA capture/compare module's operating modes. Setting the ECCFn bit in a PCA0CPMn register enables the module's CCFn interrupt. Note: PCA0 interrupts must be globally enabled before individual CCFn interrupts are recognized. PCA0 interrupts are globally enabled by setting the EA bit and the EPCA0 bit to logic 1. See Figure 22.3 for details on the PCA interrupt configuration.

PWM16	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	Operation Mode
х	Х	1	0	0	0	0	Х	Capture triggered by positive edge on CEXn
Х	Х	0	1	0	0	0	Х	Capture triggered by negative edge on CEXn
Х	Х	1	1	0	0	0	Х	Capture triggered by transition on CEXn
Х	1	0	0	1	0	0	Х	Software Timer
Х	1	0	0	1	1	0	Х	High Speed Output
Х	1	0	0	Х	1	1	Х	Frequency Output
0	1	0	0	Х	0	1	Х	8-Bit Pulse Width Modulator
1	1	0	0	Х	0	1	Х	16-Bit Pulse Width Modulator

Table 22.2. PCA0CPM Register Settings for PCA Capture/Compare Modules







